



PRELIMINARY

SOLID STATE DEVICES, INC

14849 Firestone Boulevard · La Mirada, CA 90638
 Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

SFF250/61

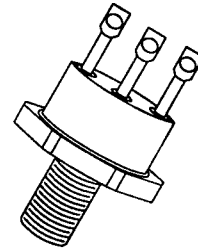
**30 AMP
 200 VOLTS
 0.085 Ω
 N-CHANNEL
 POWER MOSFET**

Designer's Data Sheet

FEATURES:

- Rugged construction with poly silicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Hermetically sealed power package
- TX, TXV and Space Level screening available
- Replaces: IRF250 Types

TO-61



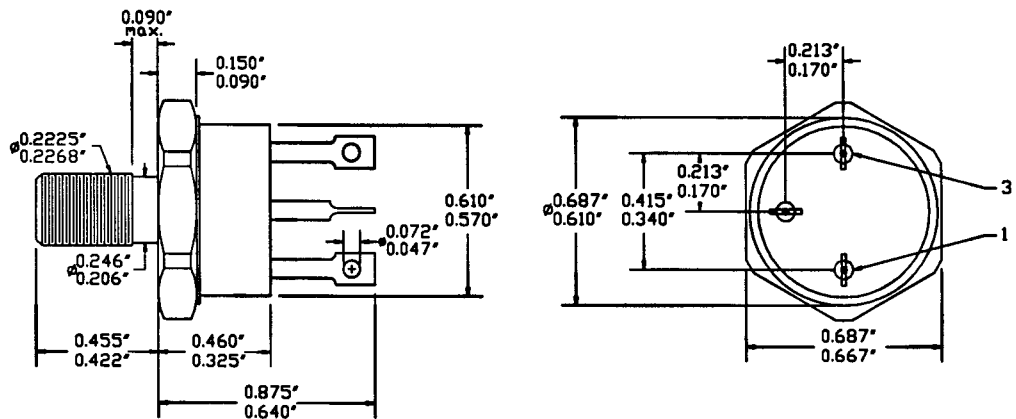
MAXIMUM RATINGS:

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V _{DS}	200	Volts
Gate to Source Voltage	V _{GS}	± 20	Volts
Continuous Drain Current	I _D	30	Amps
Operating and Storage Temperature	T _{OP} & T _{STG}	-55 to +150	°C
Thermal Resistance, Junction to Case	R _{θJC}	4	°C/W
Total Device Dissipation @ TC=25°C	P _D	125	Watts
Total Device Dissipation @ TC=55°C		95	

PACKAGE OUTLINE: TO-61

PIN OUT:

**PIN 1: SOURCE
 PIN 2: GATE
 PIN 3: DRAIN**



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00055 B

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SFF250/61

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ELECTRICAL CHARACTERISTICS @ T_J=25°C (Unless Otherwise Specified):

RATING	SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage (VGS=0 V, ID=250μA)	BV _{DSS}	200	---	---	V
Drain to Source on State Resistance (VGS=10 V, ID=60% Rated ID)	R _{DS(on)}	---	0.08	0.085	Ω
On State Drain Current (VDS > ID(on) X RDS(on) Max, VGS=10 V)	ID(on)	30	---	---	A
Gate Threshold Voltage (VDS=VGS, ID=250μA)	VGS(th)	2	3	4	V
Forward Transconductance (VDS > ID(on) X RDS(on) Max, IDS=60% rated ID)	g _{fs}	13	15	---	S(Ω)
Zero Gate Voltage Drain Current (VDS=80% rated voltage, VGS=0 V) (VDS=80% rated VDS, VGS=0 V, TA=125°C)	I _{DSS}	---	---	250 1000	μA
Gate to Source Leakage Forward Gate to Source Leakage Reverse	I _{GSS}	---	---	100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	Q _g Q _{gs} Q _{gd}	---	80 12 44	120 20 65	nC
Turn on Delay Time Rise Time Turn Off Delay Time Fall Time	t _{d(on)} t _r t _{d(off)} t _f	---	20 120 70 80	30 180 100 120	nsec
Diode Forward Voltage (IS=rated ID, VGS=0 V, T _J =25°C)	VSD	---	1.1	2.0	V
Diode Reverse Recovery Time Reverse Recovery Charge	t _{rr} Q _{RR}	140 1.8	300 3.8	630 8	nsec μC
Input Capacitance Output Capacitance Reverse Transfer Capacitance	C _{iss} C _{oss} C _{rss}	---	2600 650 150	---	pF

SAFE OPERATING AREA (S.O.A.)
 TC = 25°C, D.C. CONDITION

